Surface Mount Standard Rectifiers

eSMP® Series

Top view Bottom view

DO-219AB (SMF)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
V_{RRM}	200 V, 400 V, 600 V
I_{FSM}	25 A
V_F at I_F = 1.0 A (T_A = 125 °C)	0.85 V
I_R	5 µA
T_J max.	175 °C
Package	DO-219AB (SMF)
Diode variations	Single die

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT HALOGEN FREE

MECHANICAL DATA

Case: DO-219AB (SMF)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - for halogen-free, RoHS-compliant
Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)

PARAMETER	SYMBOL	SE10FD	SE10FG	SE10FJ	UNIT
Device marking code		AD	AG	AJ	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Maximum average forward rectified current	$I_{F(AV)}$ (1)	1.0			A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	25			A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +175			°C

Notes

(1) Free air, mounted on recommended PCB, 2 oz. pad area

ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)

PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I_F = 0.5 A	T_A = 25 °C	V_F (1)	0.90	-	V
	I_F = 1.0 A			0.95	1.05	
	I_F = 0.5 A	T_A = 125 °C		0.78	-	
	I_F = 1.0 A			0.85	0.95	
Reverse current	Rated V_R	T_A = 25 °C	I_R (2)	-	5	µA
		T_A = 125 °C		6.8	50	
Typical reverse recovery time	I_F = 0.5 A, I_R = 1.0 A, I_{rr} = 0.25 A		t_{rr}	780	-	ns
Typical junction capacitance	4.0 V, 1 MHz		C_J	7.5	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T_A = 25 °c unless otherwise noted)					
PARAMETER	SYMBOL	SE10FD	SE10FG	SE10FJ	UNIT
Typical thermal resistance	$R_{\theta JA}$ (1)	130			°C/W
	$R_{\theta JM}$ (2)	20			

Notes

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T_A = 25 °C unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ	V_C	H3B	> 8 kV

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE10FJ-M3/H	0.015	H	3000	7" diameter plastic tape and reel
SE10FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
SE10FJHM3/H (1)	0.015	H	3000	7" diameter plastic tape and reel
SE10FJHM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

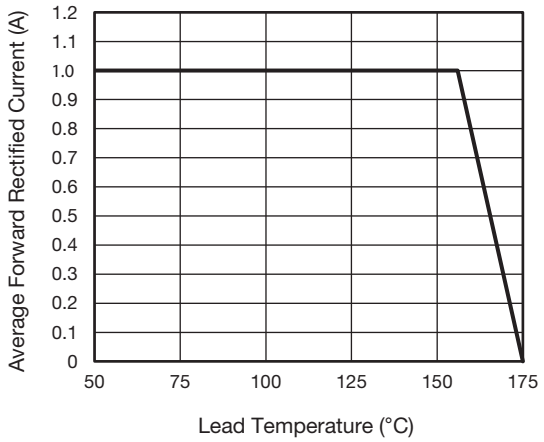


Fig. 1 - Maximum Forward Current Derating Curve

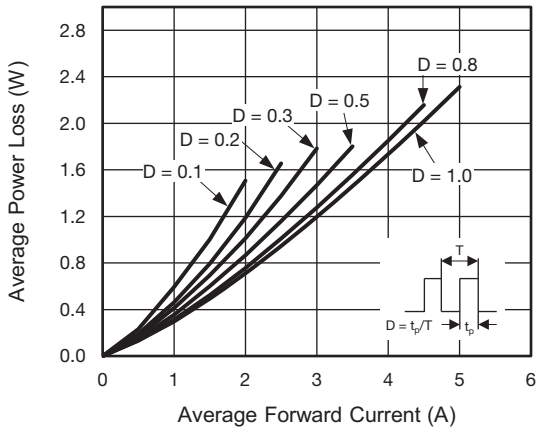


Fig. 2 - Average Power Loss Characteristics

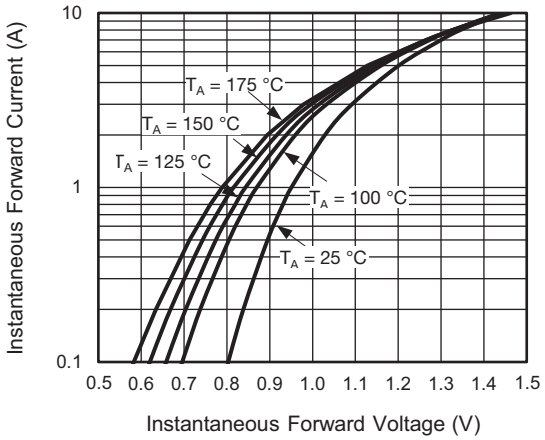


Fig. 3 - Typical Instantaneous Forward Characteristics

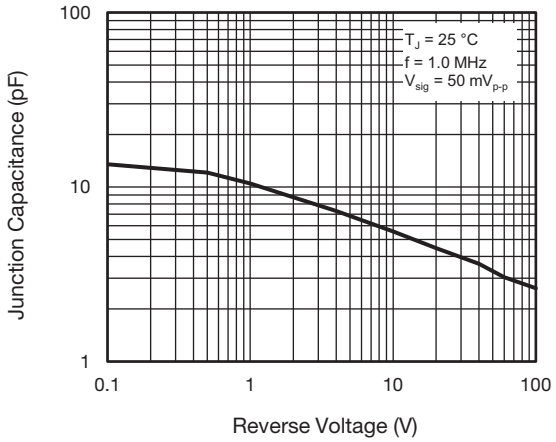


Fig. 5 - Typical Junction Capacitance

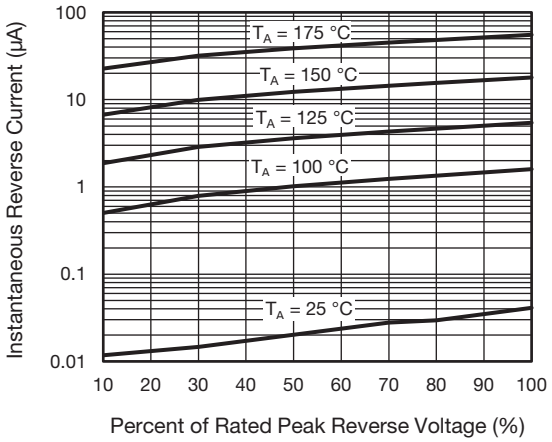


Fig. 4 - Typical Reverse Leakage Characteristics

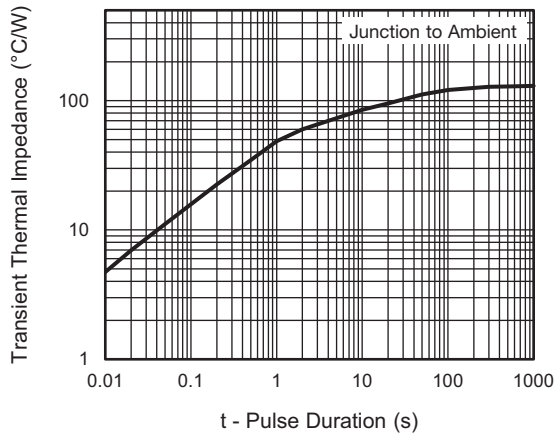
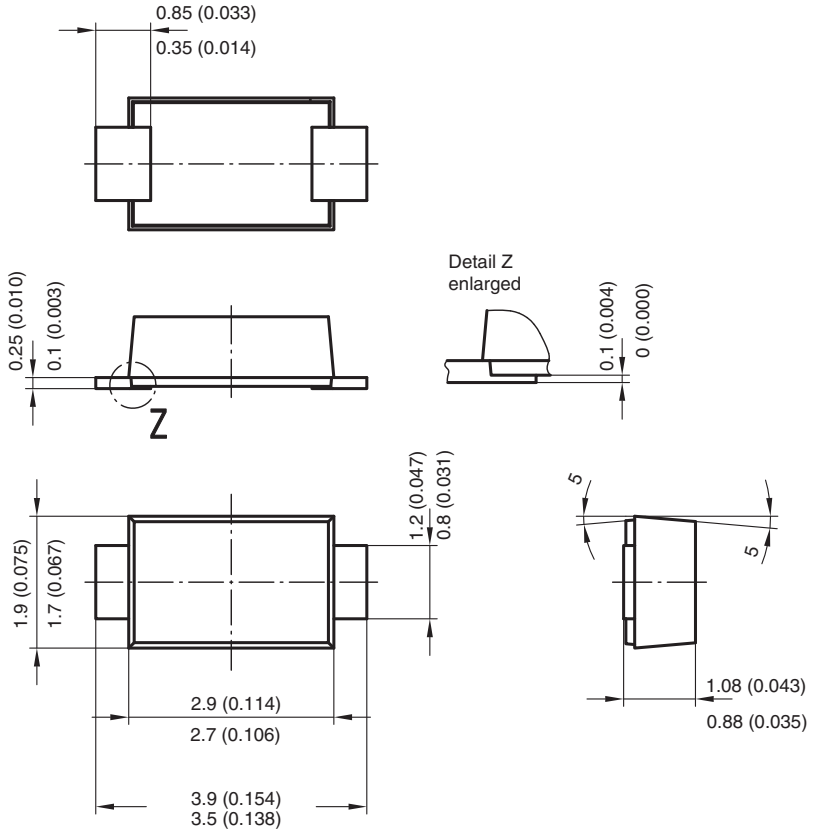
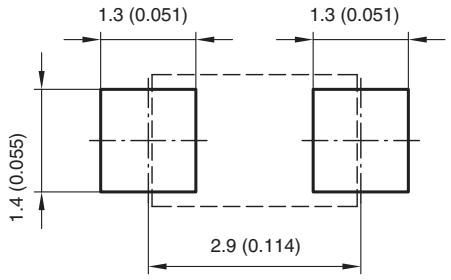


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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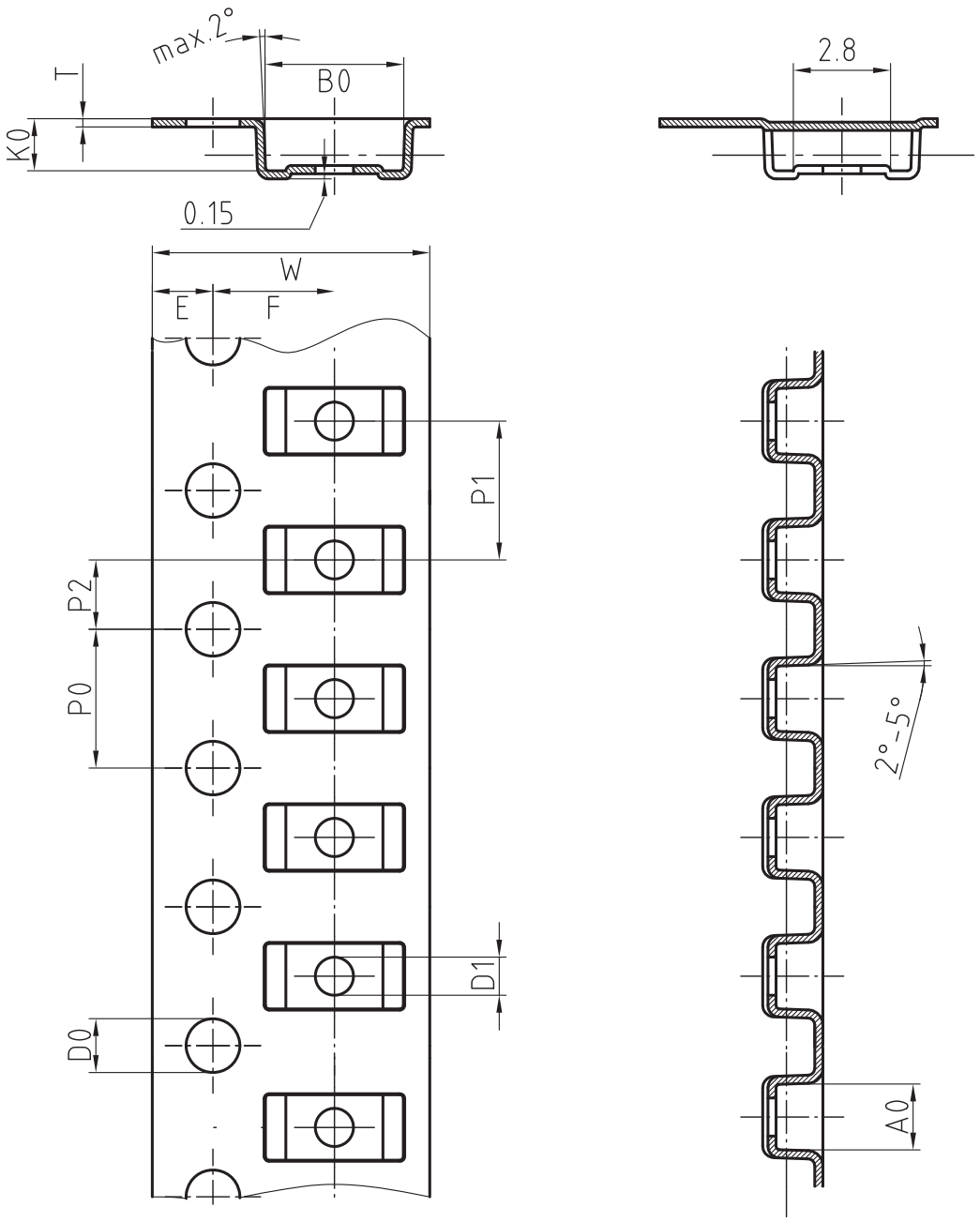
BLISTERTAPE DIMENSIONS in millimeters: **DO-219AB (SMF)**



Mat:	A0	B0	K0	W	T	P0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

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